

TrenchP™ Power MOSFETs

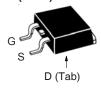
IXTA44P15T IXTP44P15T IXTQ44P15T IXTH44P15T $V_{DSS} = -150V$ $I_{D25} = -44A$ $R_{DS(on)} \le 65m\Omega$

P-Channel Enhancement Mode Avalanche Rated

TO-263 AA (IXTA)

Symbol

Weight



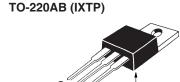
TO-263

TO-220

TO-3P

TO-247

Test Conditions





Maximum Ratings

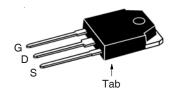
2.5

3.0

5.5

6.0

TO-3P (IXTQ)



V _{DSS}	$T_{_{\rm J}} = 25^{\circ}\text{C} \text{ to } 150^{\circ}\text{C}$	- 150	V
\mathbf{V}_{DGR}	$T_{_J} = 25^{\circ}C$ to 150°C, $R_{_{GS}} = 1M\Omega$	- 150	V
V _{GSS}	Continuous	±15	V
V _{GSM}	Transient	±25	V
I _{D25}	$T_{c} = 25^{\circ}C$	- 44	Α
I _{DM}	$T_{c} = 25^{\circ}C$, Pulse Width Limited by T_{JM}	-130	Α
I _A	$T_{c} = 25^{\circ}C$	- 22	Α
E _{AS}	$T_c = 25$ °C	1	J
P _D	T _C = 25°C	298	W
T,		-55 +150	°C
T _{JM}		150	°C
T _{stg}		-55 +150	°C
T _L	1.6mm (0.062 in.) from Case for 10s	300	°C
T _{SOLD}	Plastic Body for 10s	260	°C
М.	Mounting Torque (TO-220, TO-247 & TO-3P)	1.13/10	Nm/lb.in.

10-247 (IXTH	l)	
//		
G D S		D (Tab)
G = Gate	D	= Draiı

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_		ш	ır	

S = Source

International Standard Packages

Tab = Drain

- Avalanche Rated
- Extended FBSOA
- Fast Intrinsic Diode
- ullet Low $R_{DS(ON)}$ and Q_{G}

Advantages

g

g

g

g

- Easy to Mount
- Space Savings
- High Power Density

Applications

- High-Side Switching
- Push Pull Amplifiers
- DC Choppers
- Automatic Test Equipment
- Current Regulators
- Battery Charger Applications

SymbolTest ConditionsChara $(T_J = 25^{\circ}C, Unless Otherwise Specified)$ Min.		cterist Typ.	ristic Values yp. Max.		
BV _{DSS}	$V_{gs} = 0V, I_{D} = -250\mu A$	-150			V
$V_{\rm GS(th)}$	$V_{DS} = V_{GS}$, $I_D = -250\mu A$	- 2.0		- 4.0	V
I _{GSS}	$V_{GS} = \pm 15V, V_{DS} = 0V$			±100	nA
I _{DSS}	$V_{DS} = V_{DSS}$, $V_{GS} = 0V$ $T_{J} = 125$ °C			- 15 - 750	•
R _{DS(on)}	$V_{GS} = -10V, I_{D} = 0.5 \cdot I_{D25}, \text{ Note 1}$			65	mΩ



•			cteristic Typ.	Values Max.	
g _{fs}		$V_{DS} = -10V, I_{D} = 0.5 \cdot I_{D25}, \text{ Note 1}$	27	45	S
C _{iss})			13.4	nF
\mathbf{C}_{oss}	}	$V_{GS} = 0V, V_{DS} = -25V, f = 1MHz$		675	pF
C _{rss}	J			183	pF
t _{d(on)})	Resistive Switching Times		25	ns
t _r		•		42	ns
$\mathbf{t}_{d(off)}$	($V_{GS} = -10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 0.5 \cdot I_{D25}$		50	ns
t,	. I R	$R_{\rm G} = 1\Omega$ (External)		17	ns
$\mathbf{Q}_{g(on)}$)			175	nC
\mathbf{Q}_{gs}	}	$V_{GS} = -10V$, $V_{DS} = 0.5 \cdot V_{DSS}$, $I_{D} = 0.5 \cdot I_{D25}$		65	nC
\mathbf{Q}_{gd}	J			58	nC
R _{thJC}					0.42 °C/W
\mathbf{R}_{thCS}		TO-220		0.50	°C/W
		TO-247 & TO-3P		0.21	°C/W

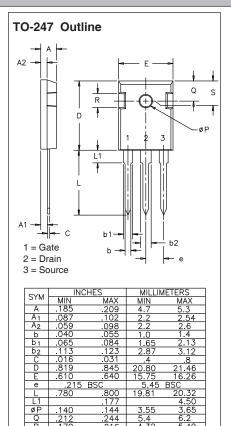
Source-Drain Diode

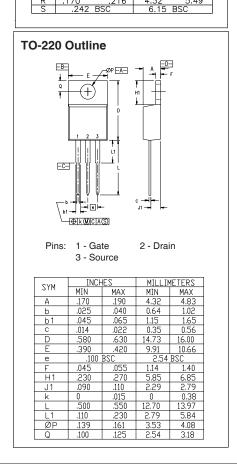
Symbol Test Conditions $(T_J = 25^{\circ}C, Unless Otherwise Specified)$		Charad Min.	cteristic Values Typ. Max.		
I _s	$V_{GS} = 0V$			- 44	Α
I _{sm}	Repetitive, Pulse Width Limited by $T_{_{\rm JM}}$			-176	Α
V _{SD}	$I_F = I_S$, $V_{GS} = 0V$, Note 1			-1.3	V
t _{rr} Q _{RM} }	$I_{_{\rm F}}$ = - 22A, -di/dt = -100A/ μ s $V_{_{\rm R}}$ = - 75V, $V_{_{ m GS}}$ = 0V		140 0.87 -12.4		ns µC A

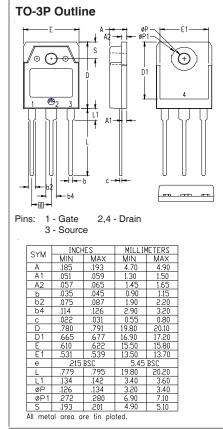
1. Pulse test, $t \le 300\mu s$, duty cycle, $d \le 2\%$. Note



IXTA44P15T IXTP44P15T IXTQ44P15T







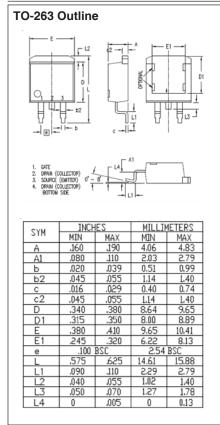




Fig. 1. Output Characteristics @ T_J = 25°C

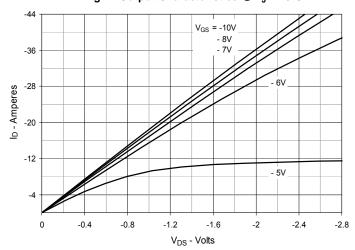


Fig. 2. Extended Output Characteristics @ T_J = 25°C

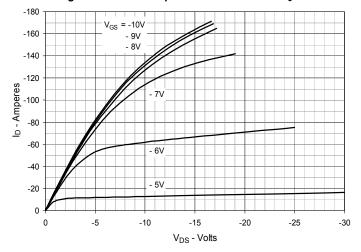


Fig. 3. Output Characteristics @ T_J = 125°C

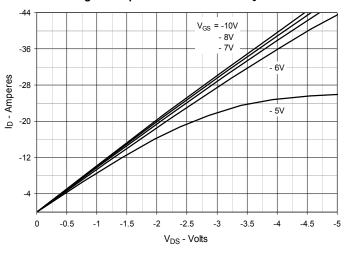


Fig. 4. $R_{DS(on)}$ Normalized to $I_D = -22A$ Value vs. Junction Temperature

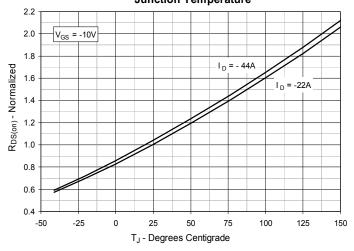


Fig. 5. $R_{DS(on)}$ Normalized to $I_D = -22A$ Value vs.

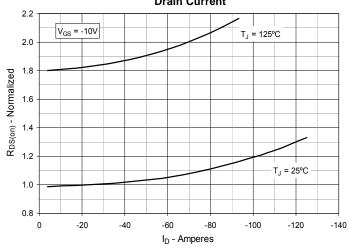
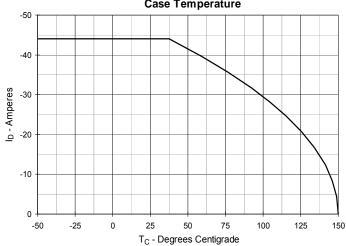


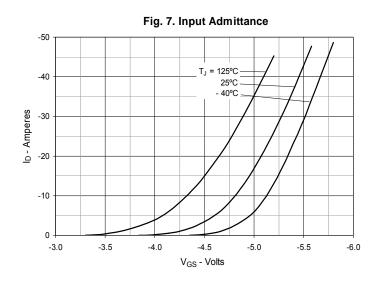
Fig. 6. Maximum Drain Current vs.

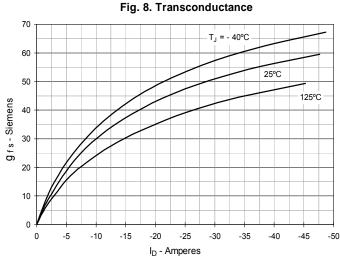
Case Temperature

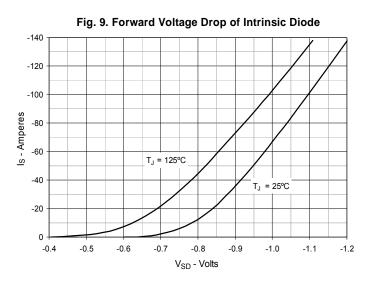


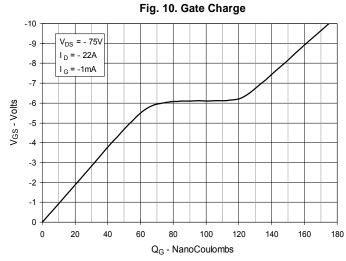
IXYS Reserves the Right to Change Limits, Test Conditions, and Dimensions.

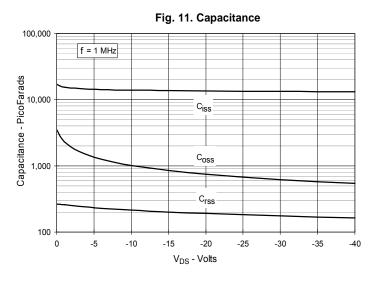












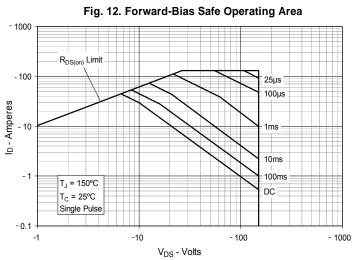




Fig. 13. Resistive Turn-on Rise Time vs.
Junction Temperature

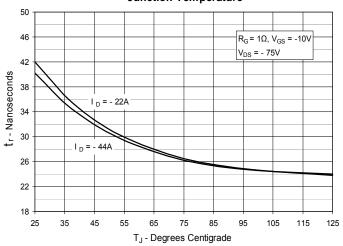


Fig. 14. Resistive Turn-on Rise Time vs.

Drain Current

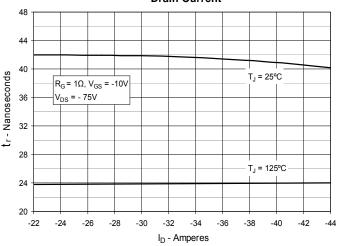


Fig. 15. Resistive Turn-on Switching Times vs.

Gate Resistance

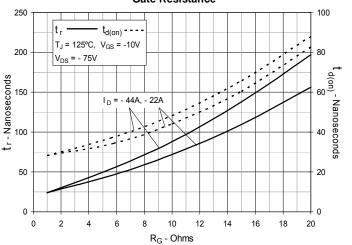


Fig. 16. Resistive Turn-off Switching Times vs.
Junction Temperature

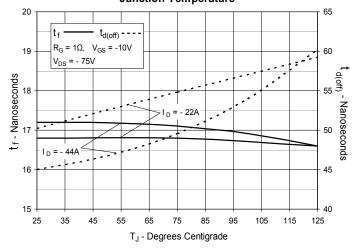


Fig. 17. Resistive Turn-off Switching Times vs.

Drain Current

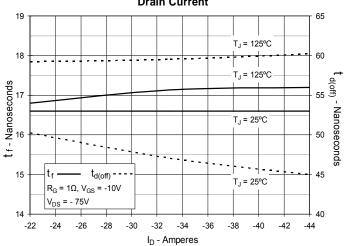
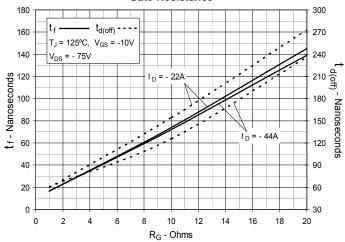


Fig. 18. Resistive Turn-off Switching Times vs.

Gate Resistance



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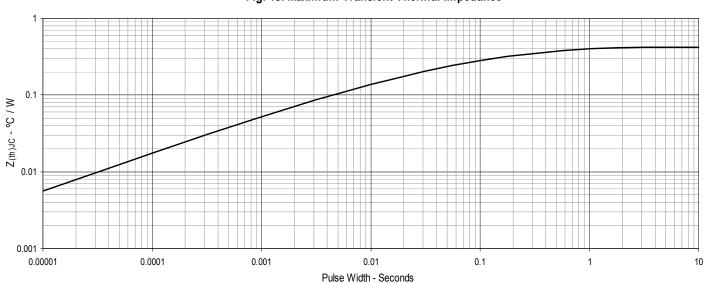


Fig. 19. Maximum Transient Thermal Impedance

